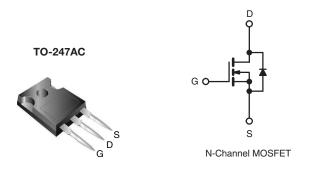


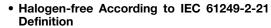
Vishay Siliconix

# **E Series Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V 0.064				
Q <sub>g</sub> max. (nC)	220				
Q <sub>gs</sub> (nC)	36				
Q <sub>gd</sub> (nC)	60				
Configuration	Single				



#### **FEATURES**





COMPLIANT

HALOGEN FREE

- Low Figure-of-Merit (FOM) Ron x Qq
- Low Input Capacitance (Ciss)
- Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Qa)
- Avalanche Energy Rated (UIS)
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
  - High-Intensity Discharge (HID)
  - Fluorescent Ballast Lighting
- Industrial
  - Welding
  - Induction Heating
  - Motor Drives
  - Battery Chargers
  - Renewable Energy
  - Solar (PV Inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and Halogen-free	SiHG47N60E-GE3

ABSOLUTE MAXIMUM RATINGS ( $T_{\rm C}$	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	600		
Gate-Source Voltage			.,	± 20	V	
Gate-Source Voltage AC (f > 1 Hz)			$V_{GS}$	30		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		47		
		T <sub>C</sub> = 100 °C	I <sub>D</sub>	30	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	145		
Linear Derating Factor				3	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	1500	mJ	
Maximum Power Dissipation			$P_{D}$	357	W	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		dV/dt	37	V/ns	
Reverse Diode dV/dt <sup>d</sup>			uv/ut	11	7 7/118	
Soldering Recommendations (Peak Temperature)	for	for 10 s		300c	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 73.5 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 6.4 A.
- c. 1.6 mm from case.
- d.  $I_{SD} \le I_D$ , dI/dt = 100 A/ $\mu$ s, starting  $T_J = 25$  °C.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40	°C/W	
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	0.33	C/VV	

<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	nless otherw	ise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 250 μA	-	0.66	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> :	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
7 0		V <sub>DS</sub> :	= 600 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 \	V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	10	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 24 A	-	0.053	0.064	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>D</sub>	<sub>S</sub> = 8 V, I <sub>D</sub> = 3 A	-	6.8	-	S
Dynamic				l		•	
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$		-	4810	-	pF
Output Capacitance	C <sub>oss</sub>	1	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		230	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		-	5	-	
Total Gate Charge	Qg			-	147	220	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 24 A, V <sub>DS</sub> = 480 V		36	-	
Gate-Drain Charge	$Q_{gd}$				60	-	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 480 \text{ V}, I_{D} = 24 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{g} = 4.4 \Omega$		-	24	50	ns
Rise Time	t <sub>r</sub>			-	11	25	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	94	140	
Fall Time	t <sub>f</sub>			-	13	26	
Gate Input Resistance	$R_g$	f = 1 MHz, open drain		-	0.65	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	47	_
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	140	A
Diode Forward Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 24 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 24 A, dl/dt = 100 A/μs, V <sub>R</sub> = 25 V		-	696	-	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	16	-	μC
Reverse Recovery Current	I <sub>RRM</sub>			-	39	-	Α



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

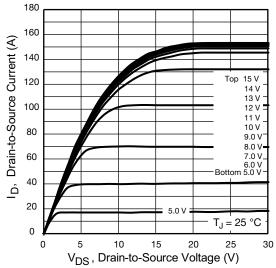


Fig. 1 - Typical Output Characteristics,  $T_C$  = 25 °C

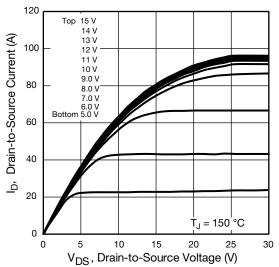
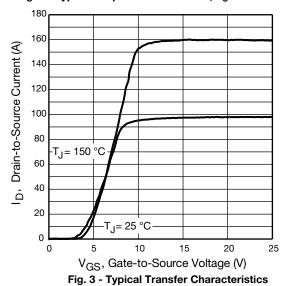


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C



I<sub>D</sub> = 24 A R<sub>DS(on)</sub>, Drain-to-Source On Resistance 2.5 2.0 (Normalized) 1.5 1.0 0.5  $V_{GS}$ 0.0 - 60 - 40 0 20 40 60 80 100 120 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

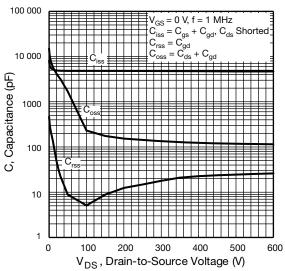


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

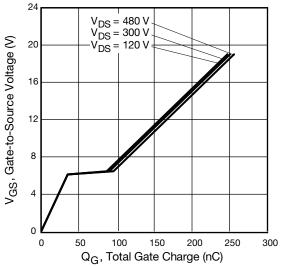


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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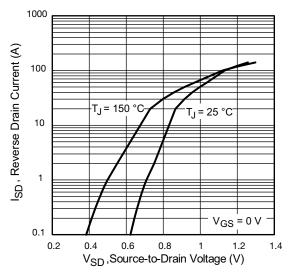


Fig. 7 - Typical Source-Drain Diode Forward Voltage

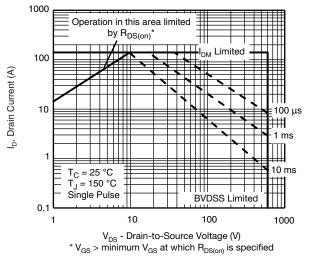


Fig. 8 - Maximum Safe Operating Area

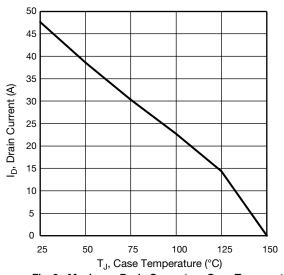


Fig. 9 - Maximum Drain Current vs. Case Temperature

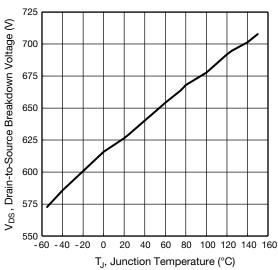


Fig. 10 - Temperature vs. Drain-to-Source Voltage

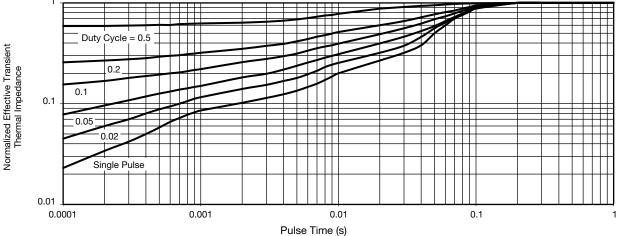


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

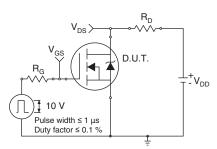


Fig. 12 - Switching Time Test Circuit

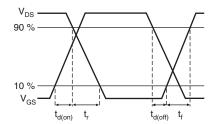


Fig. 13 - Switching Time Waveforms

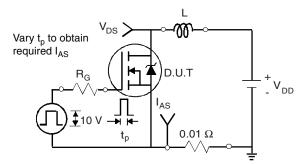


Fig. 14 - Unclamped Inductive Test Circuit

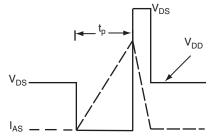


Fig. 15 - Unclamped Inductive Waveforms

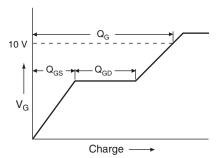


Fig. 16 - Basic Gate Charge Waveform

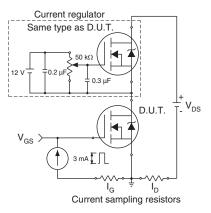
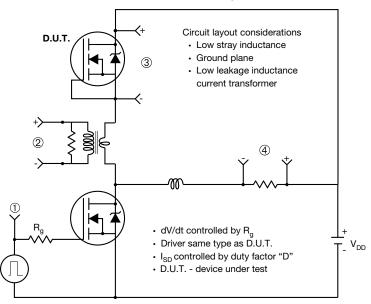


Fig. 17 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



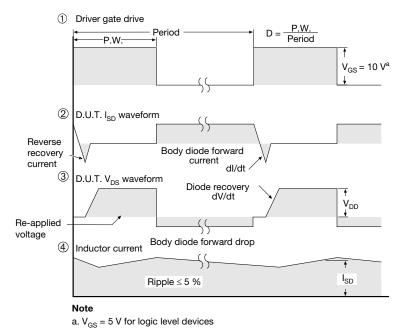


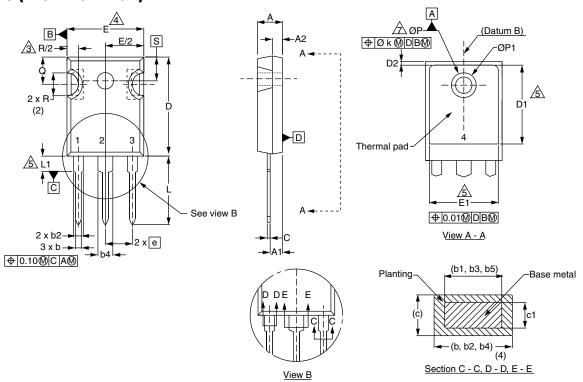
Fig. 18 - For N-Channel

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## **TO-247AC (HIGH VOLTAGE)**



	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.65	5.31	0.183	0.209
A1	2.21	2.59	0.087	0.102
A2	1.50	2.49	0.059	0.098
b	0.99	1.40	0.039	0.055
b1	0.99	1.35	0.039	0.053
b2	1.65	2.39	0.065	0.094
b3	1.65	2.37	0.065	0.093
b4	2.59	3.43	0.102	0.135
b5	2.59	3.38	0.102	0.133
С	0.38	0.86	0.015	0.034
c1	0.38	0.76	0.015	0.030
D	19.71	20.70	0.776	0.815
D1	13.08	-	0.515	-

	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
D2	0.51	1.30	0.020	0.051
Е	15.29	15.87	0.602	0.625
E1	13.72	-	0.540	-
е	5.46	BSC	0.215 BSC	
Øk	0.254		0.010	
L	14.20	16.10	0.559	0.634
L1	3.71	4.29	0.146	0.169
N	7.62	7.62 BSC		
ØΡ	3.56	3.66	0.140	0.144
Ø P1	-	7.39	-	0.291
Q	5.31	5.69	0.209	0.224
R	4.52	5.49	0.178	0.216
S	5.51 BSC		0.217 BSC	

ECN: S-81920-Rev. A, 15-Sep-08 DWG: 5971

Notes

## 1. Dimensioning and tolerancing per ASME Y14.5M-1994.

- 2. Contour of slot optional.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions D1 and E1.
- 5. Lead finish uncontrolled in L1.
- 6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").
- 7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

Document Number: 91360
Revision: 15-Sep-08
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